Datasheet

For Fan Motor Driver

Fractional Pulse Rate Converter (Conversion Ratio, 15:12)

BU6821G

General Description

This IC converts the input clock signal by 12/15 ratio and output it. It is the best when need to output the FG signal equivalent to the 8-pole motor when using the 10-pole motor with the FG signal generated from the Hall sensor signals.

Features

- 5V Power Supply
- Conversion Ratio, 15:12
- Input Frequency Range: 5 Hz to 5 kHz
- Small Package, SSOP5

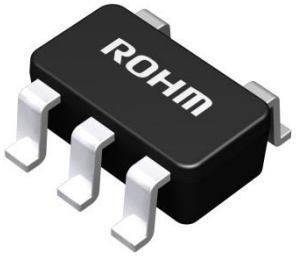
Applications

- Air Conditioners, Air Purifiers, Water Pumps, Dishwashers and Washing Machines

Key Specifications

- Input Frequency Range: 5 Hz to 5 kHz
- Driver Output Current: ±5 mA (Max)
- Maximum Junction Temperature: +125 °C

Package	W(Typ) x D(Typ) x H(Max)
SSOP5	2.90 mm x 2.80 mm x 1.25 mm



SSOP5

Typical Application Circuit

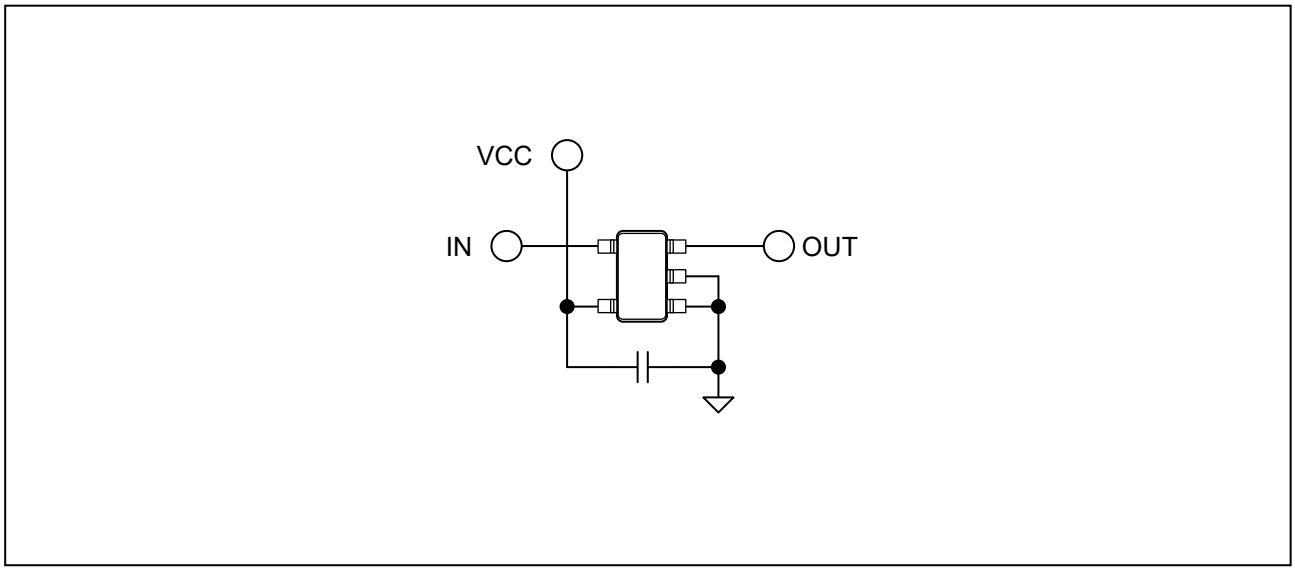


Figure 1. Application Circuit Example

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Block Diagram and Pin Configuration

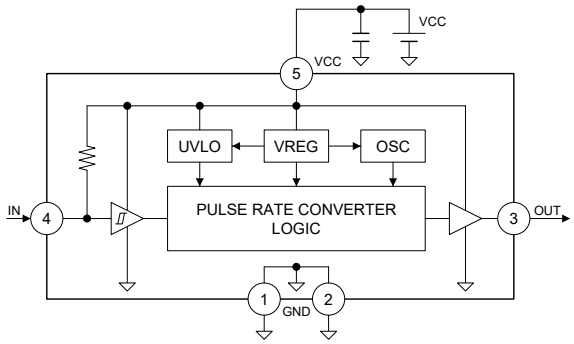


Figure 2. Block Diagram

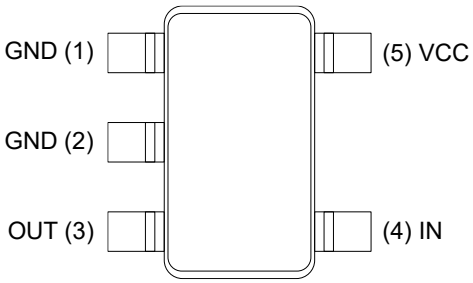


Figure 3. Pin Configuration
(Top View)

Pin Description

Pin	Name	Function	Pin	Name	Function
1	GND	Ground	5	VCC	Power supply
2	GND	Ground	-	-	-
3	OUT	Converted signal output	4	IN	Signal input pin

Description of Blocks

1. Pulse Rate Conversion Logic

It divides the input clock signal by 12/15, and output the converted signal. Signal processing is performed with reference to the fall edge of the input signal.
In addition, when the input signal frequency is out of range at signal conversion and it is judged to be too low frequency, the internal logic circuit outputs no conversion signal (pass through). On the other hand, when it is judged to be too high frequency, it outputs 35 kHz (Typ) signal.

2. Signal Input Pin

The IN pin is pulled up to VCC internally by a 500 kΩ (Typ) resistor. When using in conjunction with the open-collector / drain output, the IN pin can be connected directly.

3. Signal Output Pin

The OUT pin is CMOS output. When connecting to the base pin of a bipolar transistor, please do not exceed the rated current by taking countermeasure such as inserting a current limiting resistor.

4. Under Voltage Lock Out (UVLO) Circuit

To secure the lowest power supply voltage necessary to operate the internal circuit, and to prevent under voltage malfunctions, an UVLO circuit is built into the internal circuit. When the power supply voltage falls to V_{UVL} and below, the internal circuit forces output low. When the voltage rises to V_{UVH} and above, the UVLO circuit ends the lock out operation and returns to normal operation.

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Absolute Maximum Ratings (Tj=25 °C)

Parameter	Symbol	Rating	Unit
Supply Voltage	V_{CC}	7.0*(Note 1)*	V
Input Voltage	V_{IN}	-0.3 to V_{CC}	V
Maximum Input Frequency	f_{INMAX}	10	kHz
Driver Outputs	I_{OMAX}	±5*(Note 1)*	mA
Storage Temperature Range	Tstg	-55 to +125	°C
Maximum Junction Temperature	Tjmax	125	°C

(Note) All voltages are with respect to ground unless otherwise specified.

(Note 1) Do not exceed ASO.

Caution 1: *Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.*

Caution 2: *Should by any chance the maximum junction temperature rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, design a PCB with thermal resistance taken into consideration by increasing board size and copper area so as not to exceed the maximum junction temperature rating.*

Thermal Resistance*(Note 2)*

Parameter	Symbol	Thermal Resistance (Typ)		Unit
		1s*(Note 4)*	2s2p*(Note 5)*	
SSOP5				
Junction to Ambient	θ_{JA}	376.5	185.4	°C/W
Junction to Top Characterization Parameter*(Note 3)*	Ψ_{JT}	40	30	°C/W

(Note 2) Based on JESD51-2A(Still-Air).

(Note 3) The thermal characterization parameter to report the difference between junction temperature and the temperature at the top center of the outside surface of the component package.

(Note 4) Using a PCB board based on JESD51-3.

(Note 5) Using a PCB board based on JESD51-7.

Layer Number of Measurement Board	Material	Board Size
Single	FR-4	114.3 mm x 76.2 mm x 1.57 mmt

Top	
Copper Pattern	Thickness
Footprints and Traces	70 µm

Layer Number of Measurement Board	Material	Board Size
4 Layers	FR-4	114.3 mm x 76.2 mm x 1.6 mmt

Top		2 Internal Layers		Bottom	
Copper Pattern	Thickness	Copper Pattern	Thickness	Copper Pattern	Thickness
Footprints and Traces	70 µm	74.2 mm x 74.2 mm	35 µm	74.2 mm x 74.2 mm	70 µm

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Recommended Operating Conditions (Tj=25 °C)

Parameter	Symbol	Min	Typ	Max	Unit
Supply Voltage	V_{CC}	4.5	5.0	5.5	V
Junction Temperature	Tj	-40	-	+110	°C
Input Frequency Range	f_{IN}	5	-	5k	Hz
Input Signal Duty Range	F_{DUTY}	15	-	85	%

(Note) All voltages are with respect to ground unless otherwise specified.

Electrical Characteristics (Unless otherwise specified V_{CC}=5 V and T_j=25 °C)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Power Supply						
Quiescence Current	I_{CCQ}	0.3	0.46	1.0	mA	V_{IN}=0 V
Input						
Input Bias Current	I_{IN}	6	10	15	μA	V_{IN}=0 V
Input High Voltage	V_{INH}	2.0	-	V_{CC}	V	
Input Low Voltage	V_{INL}	0	-	0.8	V	
Output						
Output High Voltage	V_{OUTH}	V_{CC}-0.40	V_{CC}-0.08	V_{CC}	V	I_O=-2 mA
Output Low Voltage	V_{OUTL}	0	0.02	0.30	V	I_O=2 mA
Under Voltage Lock Out						
Release Voltage	V_{UVH}	3.3	3.6	3.9	V	
Lockout Voltage	V_{UVL}	2.7	3.0	3.3	V	

(Note) All voltages are with respect to ground unless otherwise specified.

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Typical Performance Curves (Reference Data)

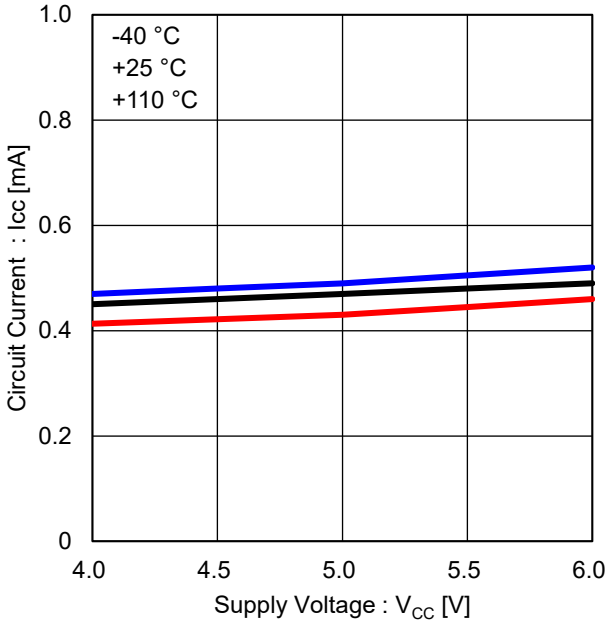


Figure 4. Operating Current
(IN = 1kHz)

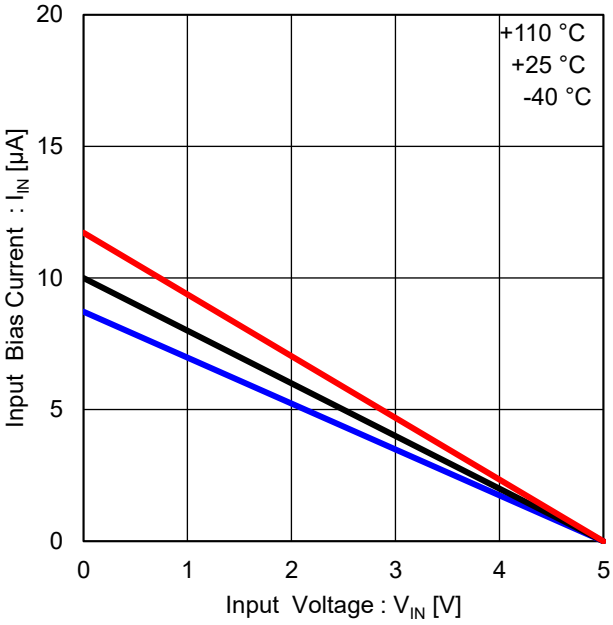


Figure 5. Input Bias Current

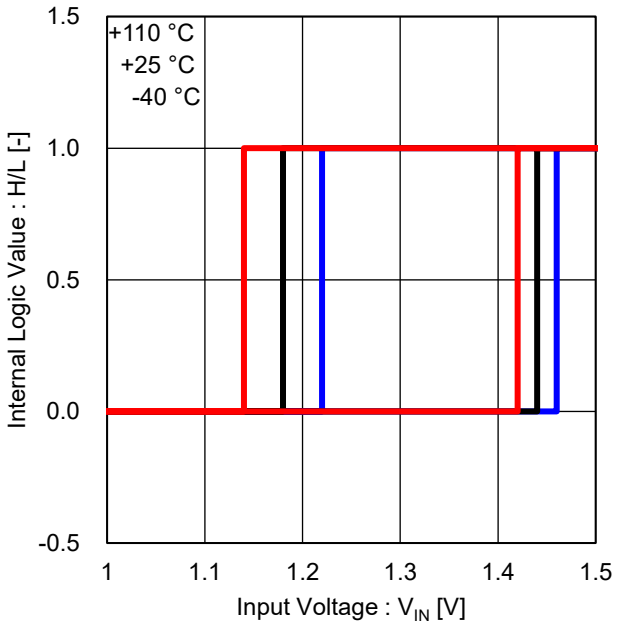


Figure 6. Input Threshold Voltage

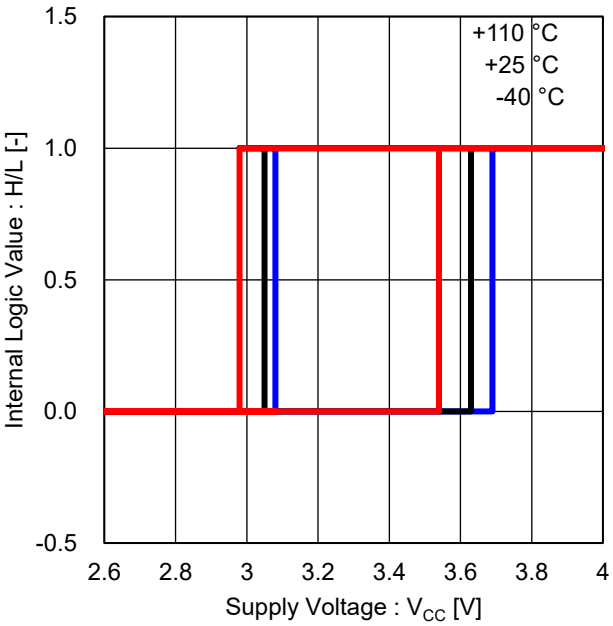


Figure 7. Under Voltage Lock Out

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Typical Performance Curves (Reference Data) - **continued**

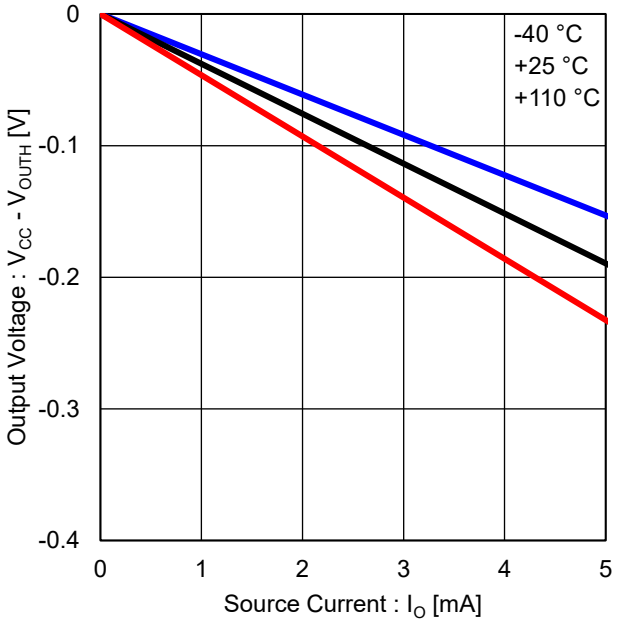


Figure 8. Output High Voltage

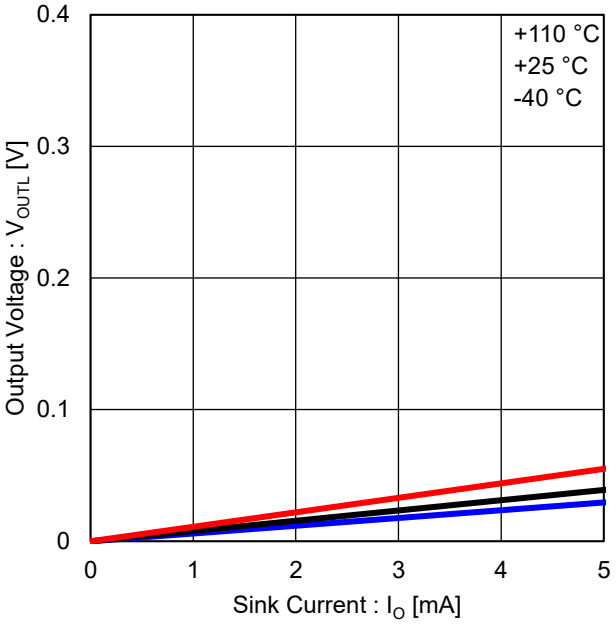


Figure 9. Output Low Voltage

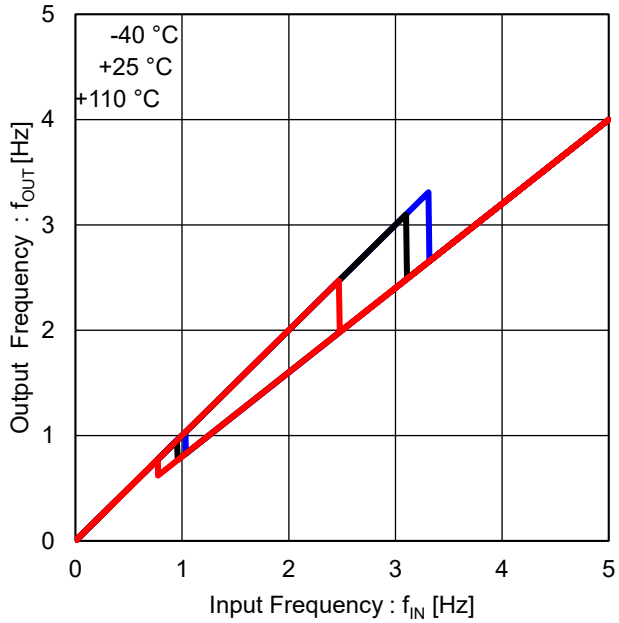


Figure 10. Output vs Input Frequency Characteristics (Low Frequency)

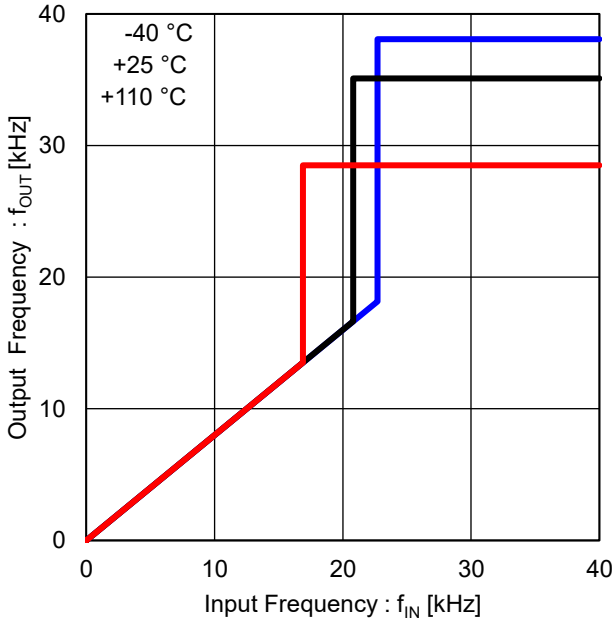


Figure 11. Output vs Input Frequency Characteristics

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Timing Chart

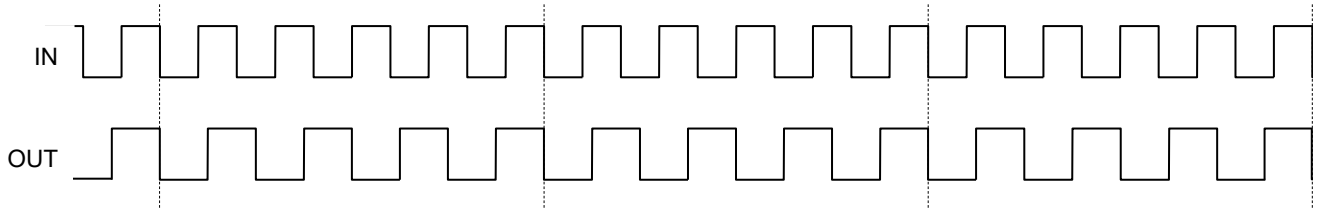


Figure 12. Timing Chart

I/O Equivalence Circuits

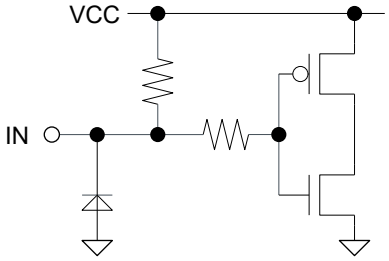


Figure 13. IN

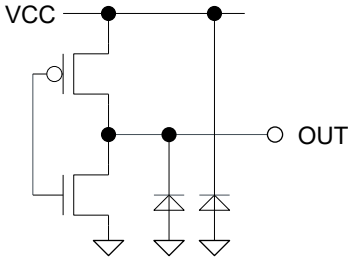


Figure 14. OUT, VCC

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Operational Notes

1. **Reverse Connection of Power Supply**
   Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

2. **Power Supply Lines**
   Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

3. **Ground Voltage**
   Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition. However, pins that drive inductive loads (e.g. motor driver outputs, DC-DC converter outputs) may inevitably go below ground due to back EMF or electromotive force. In such cases, the user should make sure that such voltages going below ground will not cause the IC and the system to malfunction by examining carefully all relevant factors and conditions such as motor characteristics, supply voltage, operating frequency and PCB wiring to name a few.

4. **Ground Wiring Pattern**
   When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

5. **Recommended Operating Conditions**
   The function and operation of the IC are guaranteed within the range specified by the recommended operating conditions. The characteristic values are guaranteed only under the conditions of each item specified by the electrical characteristics.

6. **Inrush Current**
   When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

7. **Operation Under Strong Electromagnetic Field**
   Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

8. **Testing on Application Boards**
   When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

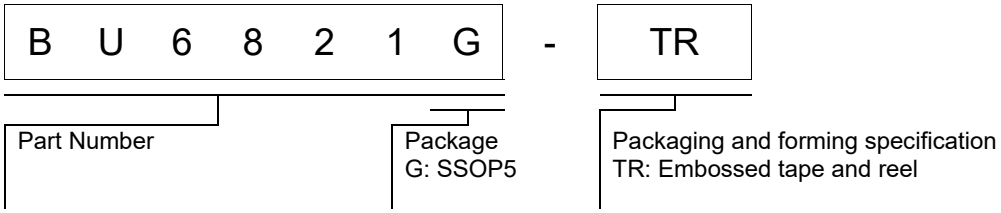
9. **Inter-pin Short and Mounting Errors**
   Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

10. **Regarding the Input Pin of the IC**
    In the construction of this IC, P-N junctions are inevitably formed creating parasitic diodes or transistors. The operation of these parasitic elements can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions which cause these parasitic elements to operate, such as applying a voltage to an input pin lower than the ground voltage should be avoided. Furthermore, do not apply a voltage to the input pins when no power supply voltage is applied to the IC. Even if the power supply voltage is applied, make sure that the input pins have voltages within the values specified in the electrical characteristics of this IC.

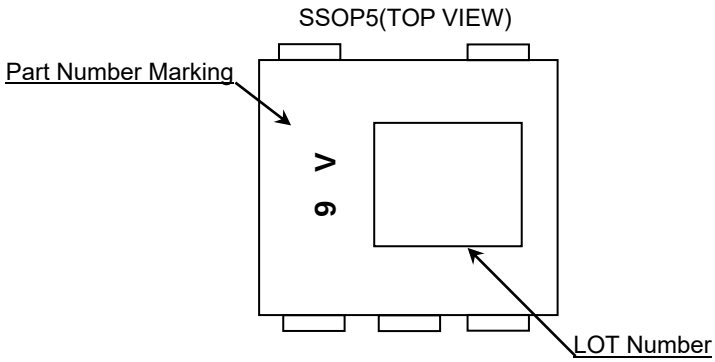
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Ordering Information



Marking Diagram

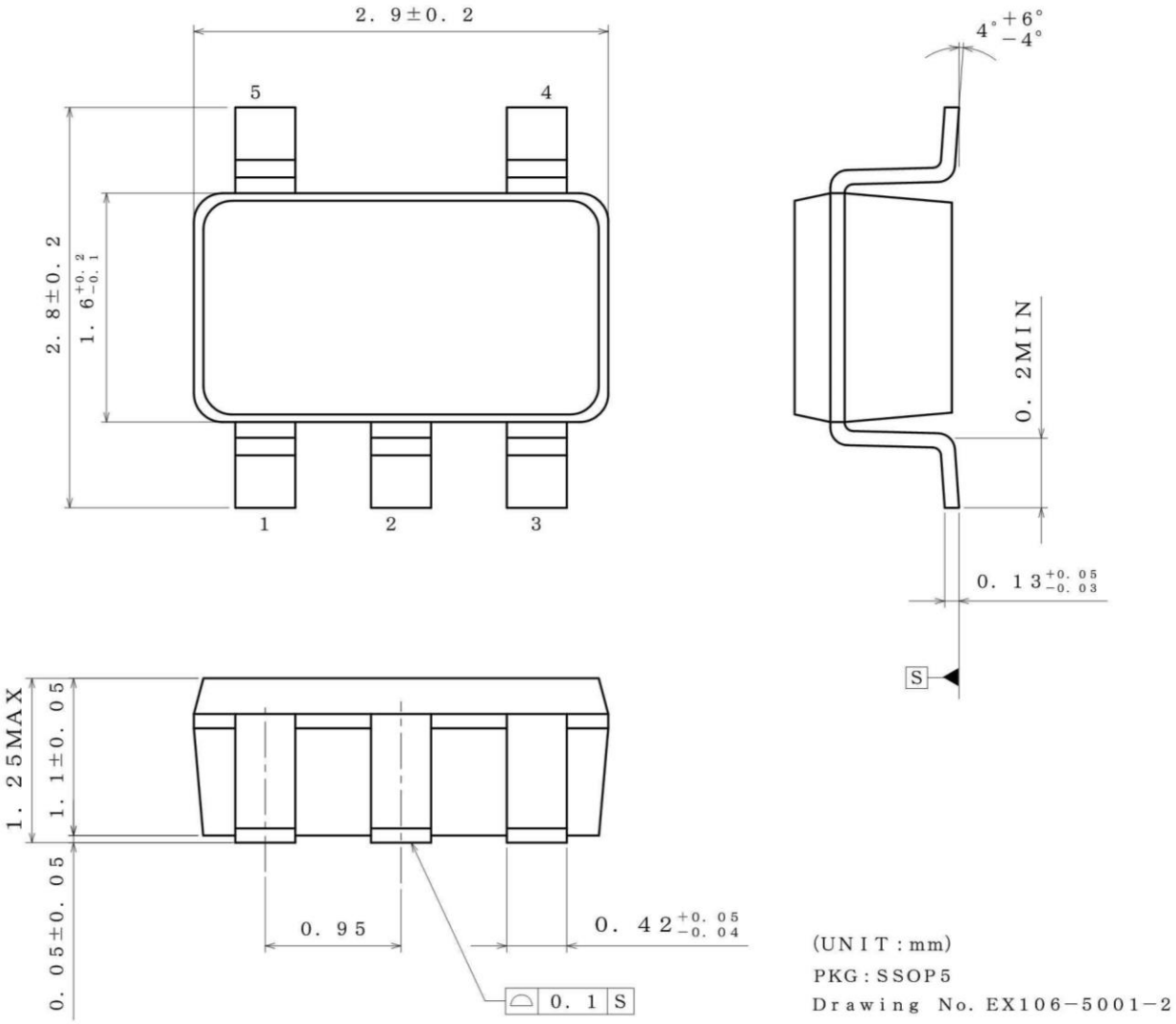


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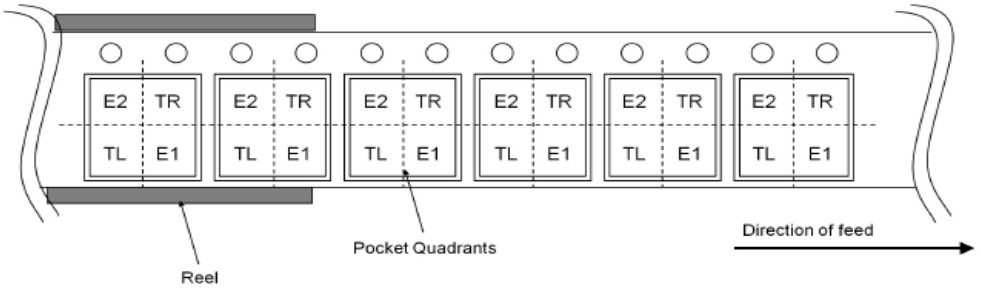
Physical Dimension and Packing Information

Package Name	SSOP5



< Tape and Reel Information >

Tape	Embossed carrier tape
Quantity	3000pcs
Direction of feed	TR (The direction is the 1pin of product is at the upper right when you hold reel on the left hand and you pull out the tape on the right hand)



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Revision History

Date	Revision	Changes
29.May.2018	001	New Release
30.Sep.2021	002	Page 1: Applications are added.

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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASSⅡb	CLASSⅢ
CLASSⅣ		CLASSⅢ	

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   [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
   [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl_2, H_2S, NH_3, SO_2, and NO_2
   [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
   [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
   [f] Sealing or coating our Products with resin or other coating materials
   [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.) ; or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
   [h] Use of the Products in places subject to dew condensation

4. The Products are not subject to radiation-proof design.

5. Please verify and confirm characteristics of the final or mounted products in using the Products.

6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

8. Confirm that operation temperature is within the specified range described in the product specification.

9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.

2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.

2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
   - [a] the Products are exposed to sea winds or corrosive gases, including Cl_2, H_2S, NH_3, SO_2, and NO_2
   - [b] the temperature or humidity exceeds those recommended by ROHM
   - [c] the Products are exposed to direct sunshine or condensation
   - [d] the Products are exposed to high Electrostatic

2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.

3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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